

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

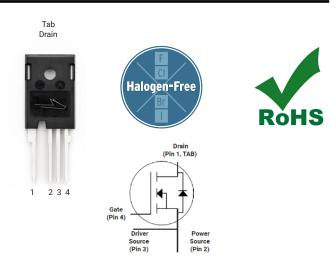
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Part Number	Package	Marking
E3M0021120K	TO-247-4L	E3M0021120K

Maximum Ratings (T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V _{DSmax}	Drain - Source Voltage		1200	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
	Continuous Drain Current, V _{GS} = 15 V $\frac{T_{C} = 25^{\circ}C}{T_{C} = 100^{\circ}C}$		104	A	Fig. 19 Note: 2
ID			75		
I _{D(pulse)}	Pulsed Drain Current, Pulse width t_P limited by T_{jmax}			А	Fig. 22
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$		405	W	Fig. 20 Note: 2
T_{J} , T_{stg}	Operating Junction and Storage Temperature		-55 to +175	°C	
TL	Solder Temperature, 1.6mm (0.063") from case for 10s		260	°C	
M _d	Mounting Torque , M3 or 6-32 screw		1 8.8	Nm lbf-in	

Note (1): Recommended turn off / turn on gate voltage V_{GS} - 4V...0V / +15V

Note (2): Verified by design

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			V	V _{GS} = 0 V, I _D = 100 µA	
M		1.8	2.9	3.6	V	V _{DS} = V _{GS} , I _D = 17.1 mA	Fig. 11
$V_{GS(th)}$	Gate Threshold Voltage		2.3		V	V_{DS} = V_{GS} , I_D = 17.1 mA, T_J = 175°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V _{DS} = 1200 V, V _{GS} = 0 V	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
R _{DS(on)}	Drain-Source On-State Resistance		21	28.8	mΩ	V _{GS} = 15 V, I _D = 62.1 A	Fig. 4,
• DS(on)			34.7			V _{GS} = 15 V, I _D = 62.1 A, T _J = 175°C	5, 6
g fs	Transconductance		38		s	V _{DS} = 20 V, I _{DS} = 62.1 A	Fig. 7
3			35			V _{DS} = 20 V, I _{DS} = 62.1 A, T _J = 175°C	
C _{iss}	Input Capacitance		5100				
C_{oss}	Output Capacitance		174		pF	V_{GS} = 0 V, V_{DS} = 0V to 1000 V	Fig. 17, 18
C_{rss}	Reverse Transfer Capacitance		11		1	F = 100 kHz	
E _{oss}	Coss Stored Energy		98		μJ	Vac = 25 mV	Fig. 16
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		210	1	pF	- V _{GS} = 0 V, V _{DS} = 0 800V	Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		323	1	pF		
Eon	Turn-On Switching Energy (External Diode)		0.96			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 62.12 A,	Fig. 26, 28
E _{OFF}	Turn Off Switching Energy (External Diode)		0.45		mJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 µH, T _J = 175°C FWD = External SiC DIODE	
Eon	Turn-On Switching Energy (Body Diode FWD)		1.99			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 62.12 A,	Fig. 26, 28
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		0.43		mJ	$R_{G(ext)}$ = 2.5 Ω, L= 135 µH, T _J = 175°C FWD = Internal Body Diode	
$t_{\text{d(on)}}$	Turn-On Delay Time		17				
tr	Rise Time		39]	$\label{eq:VDD} \begin{split} V_{\text{DD}} &= 800 \text{ V}, \text{V}_{\text{GS}} = -4 \text{V}/15 \text{V} \\ \text{I}_{\text{D}} &= 62.12 \text{A}, \text{R}_{\text{G}(\text{ext})} = 2.5 \Omega, \end{split}$	Fig. 27, 28
$t_{d(off)}$	Turn-Off Delay Time		54		ns	Timing relative to V _{DS} Inductive load	
t _f	Fall Time		13				
R _{G(int)}	Internal Gate Resistance		1.7		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		59			V _{DS} = 800 V, V _{GS} = -4 V/15 V	
Q_{gd}	Gate to Drain Charge		53	_	nC	I _D = 62.12 A	Fig. 12
Q_g	Total Gate Charge		177			Per IEC60747-8-4 pg 21	

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V $C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V

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Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
N		4.9		V	V _{GS} = -4 V, I _{SD} = 31.1 A, T _J = 25 °C	Fig. 8,
V _{SD}	Diode Forward Voltage	4.4		V	V _{GS} = -4 V, I _{SD} = 31.1 A, T _J = 175 °C	9,10
Is	Continuous Diode Forward Current		73	А	V_{gs} = -4 V, T _c = 25°C	
I _{S, pulse}	Diode pulse Current		248	А	$V_{_{GS}}$ = -4 V, pulse width $t_{\rm P}$ limited by T_{jmax}	
t _{rr}	Reverse Recover time	30		ns		
Q _{rr}	Reverse Recovery Charge	1264		nC	V _{GS} = -4 V, I _{SD} = 62.1 A, V _R = 800 V dif/dt = 4845 A/µs, T _J = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	64		A		
t _{rr}	Reverse Recover time	45		ns		
Q _{rr}	Reverse Recovery Charge	1050		nC	V _{GS} = -4 V, I _{SD} = 62.1 A, V _R = 800 V dif/dt = 2415 A/μs, Τ _J = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	13		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
R _{0JC}	Thermal Resistance from Junction to Case	0.28	0.37	°C/W		Fig. 21



Typical Performance

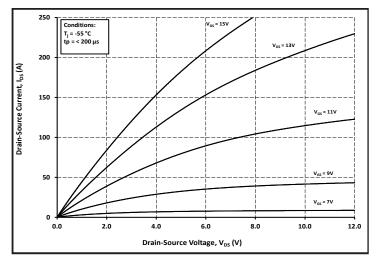
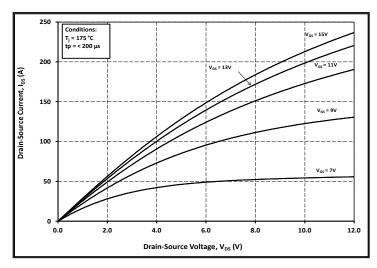
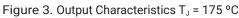


Figure 1. Output Characteristics T_J = -55 °C





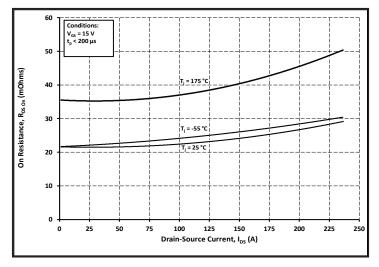


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

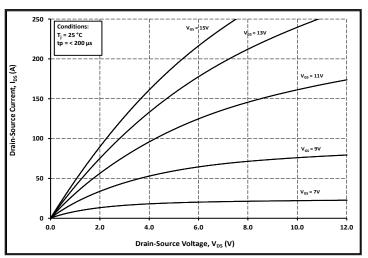


Figure 2. Output Characteristics T_J = 25 °C

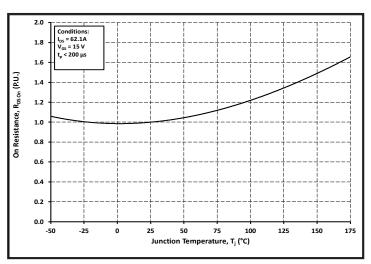


Figure 4. Normalized On-Resistance vs. Temperature

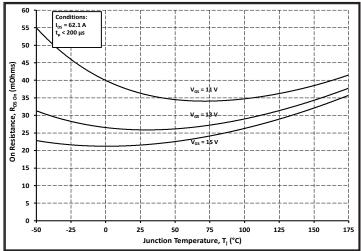


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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Typical Performance

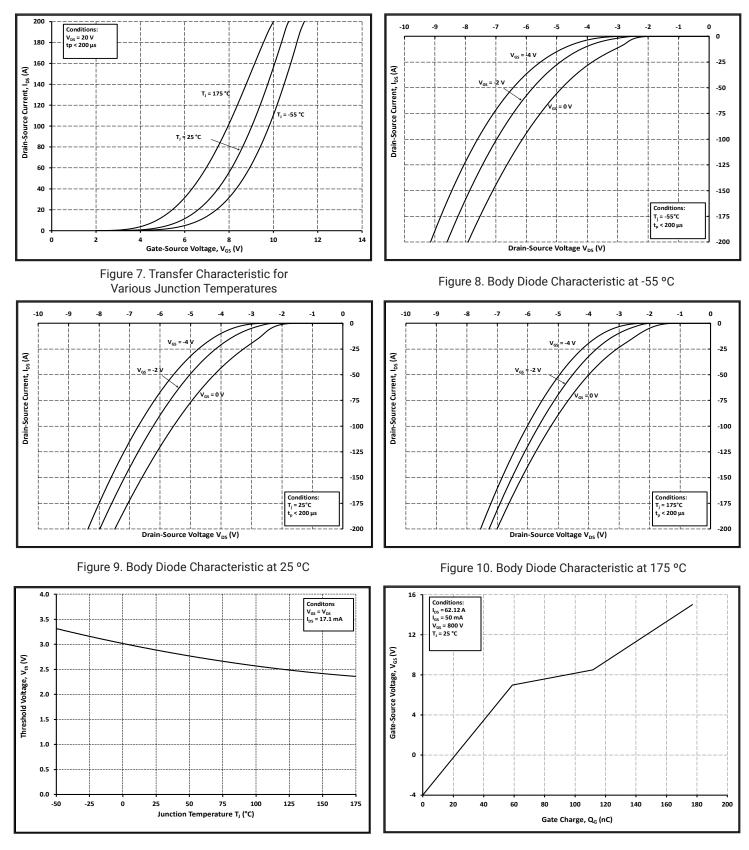


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics

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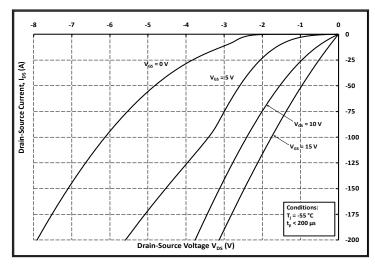


Figure 13. 3rd Quadrant Characteristic at -55 °C

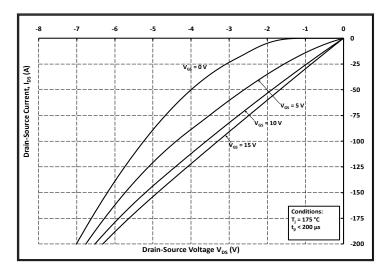
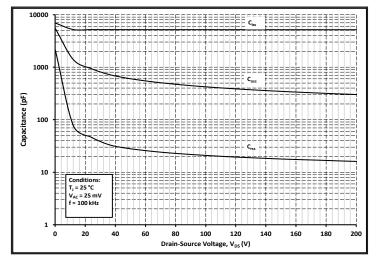
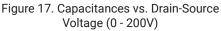
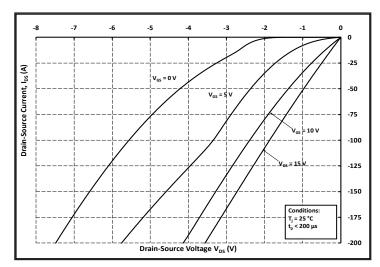
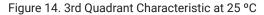


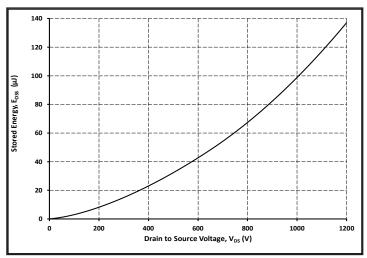
Figure 15. 3rd Quadrant Characteristic at 175 °C













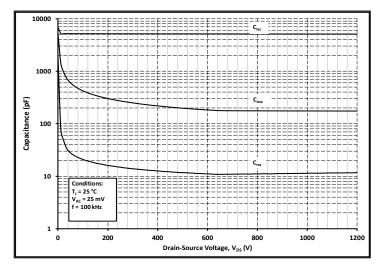
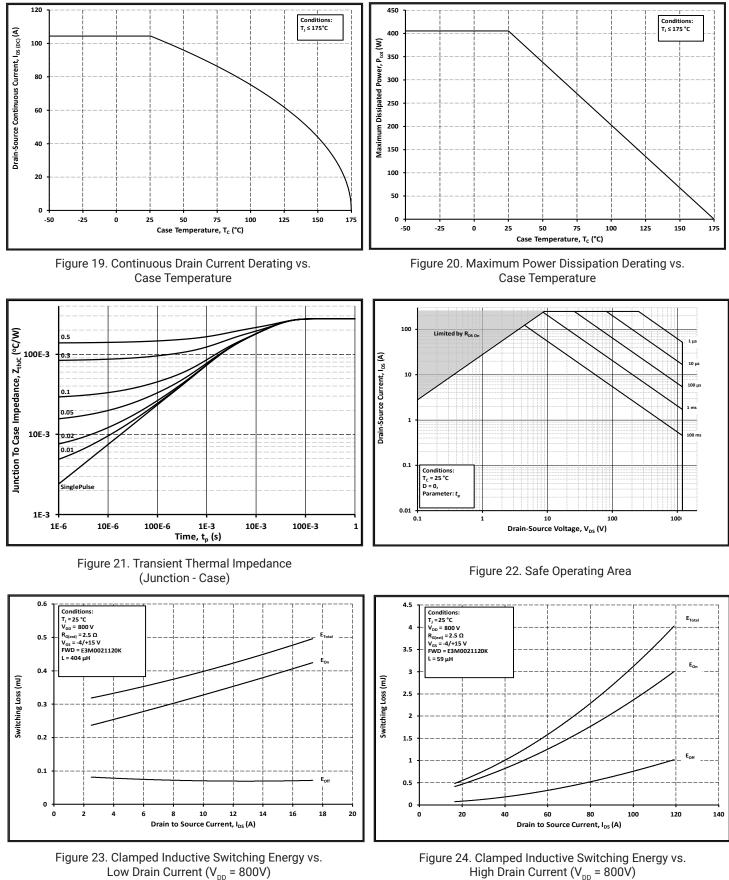


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

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Typical Performance



Low Drain Current (V_{DD} = 800V)

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Typical Performance

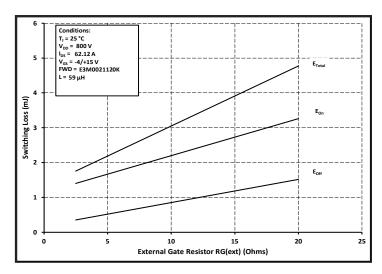


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

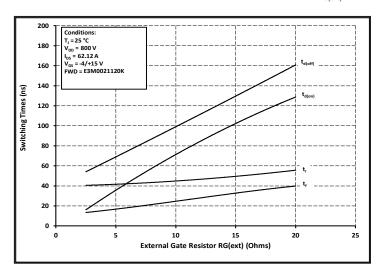


Figure 27. Switching Times vs. $R_{G(ext)}$

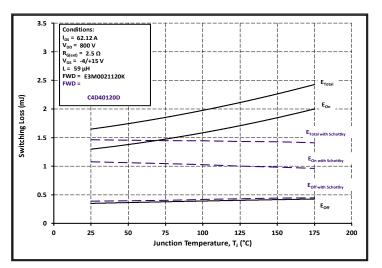


Figure 26. Clamped Inductive Switching Energy vs. Temperature

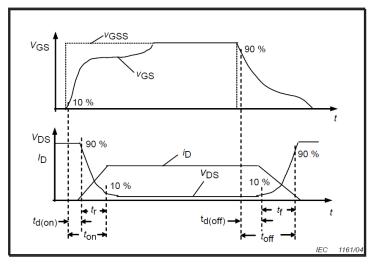


Figure 28. Switching Times Definition

Test Circuit Schematic



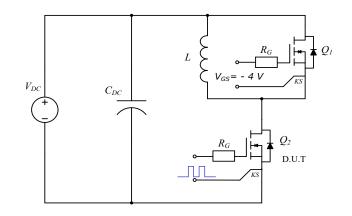
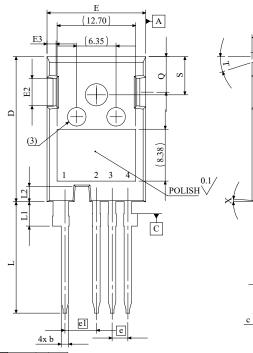


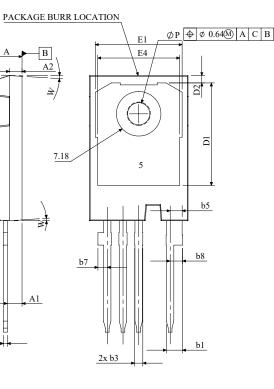
Figure 29. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions





⊕0.25M B AM

SYMBOL	MIN (mm)	MAX (mm)	
А	4.83	5.21	
A1	2.29	2.54	
A2	1.91	2.16	
b	1.07	1.33	
b1	2.39	2.94	
b3	1.07	1.60	
b5	2.39	2.69	
b7	1.30	1.70	
b8	1.80	2.20	
с	0.55	0.68	
D	23.30	23.60	
D1	16.25	17.65	
D2	0.95	1.25	
E	15.75	16.13	
E1	13.1	14.15	
E2	3.68	5.10	
E3	1.00	1.90	
E4	12.38	13.43	
e	2.54 BSC		
e1	5.08	3 BSC	
L	17.31	17.82	
L1	3.97	4.37	
L2	2.35	2.65	
ØP	3.51	3.65	
Q	5.49	6.00	
S	6.04	6.30	
Т		° REF.	
W		REF.	
Х	4°	REF.	

1	DRAIN
2	SOURCE
3	DRIVER SOURCE
4	GATE
5	DRAIN

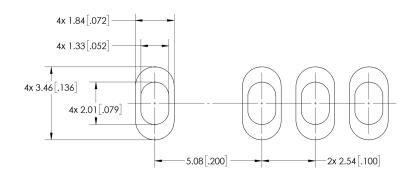
NOTE:

- 1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
- 2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

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Recommended Solder Pad Layout



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Revision history

Document Version	Date of release	Descriptiion of changes
1.0	August-2022	Initial datasheet

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